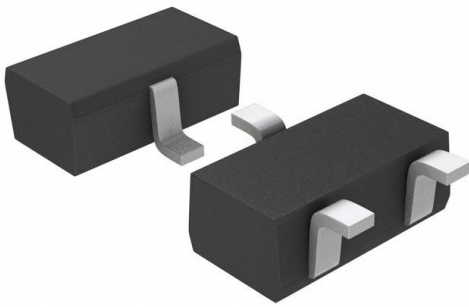


# 2SC6036G0L Datasheet

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DiGi Electronics Part Number	2SC6036G0L-DG
Manufacturer	<a href="#">Panasonic Electronic Components</a>
Manufacturer Product Number	2SC6036G0L
Description	TRANS NPN 12V 0.5A SSSMINI3
Detailed Description	Bipolar (BJT) Transistor NPN 12 V 500 mA 200MHz 100 mW Surface Mount SSSMini3-F2



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

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## Purchase and inquiry

Manufacturer Product Number:

2SC6036G0L

Series:

-

Transistor Type:

NPN

Voltage - Collector Emitter Breakdown (Max):

12 V

Current - Collector Cutoff (Max):

100nA (ICBO)

Power - Max:

100 mW

Operating Temperature:

125°C (TJ)

Package / Case:

SOT-723

Base Product Number:

2SC6036

Manufacturer:

Panasonic Electronic Components

Product Status:

Obsolete

Current - Collector (Ic) (Max):

500 mA

Vce Saturation (Max) @ Ib, Ic:

250mV @ 10mA, 200mA

DC Current Gain (hFE) (Min) @ Ic, Vce:

270 @ 10mA, 2V

Frequency - Transition:

200MHz

Mounting Type:

Surface Mount

Supplier Device Package:

SSSMINI3-F2

## Environmental & Export classification

Moisture Sensitivity Level (MSL):

1 (Unlimited)

HTSUS:

8541.21.0075

ECCN:

EAR99

# 2SC6036

## Silicon NPN epitaxial planar type

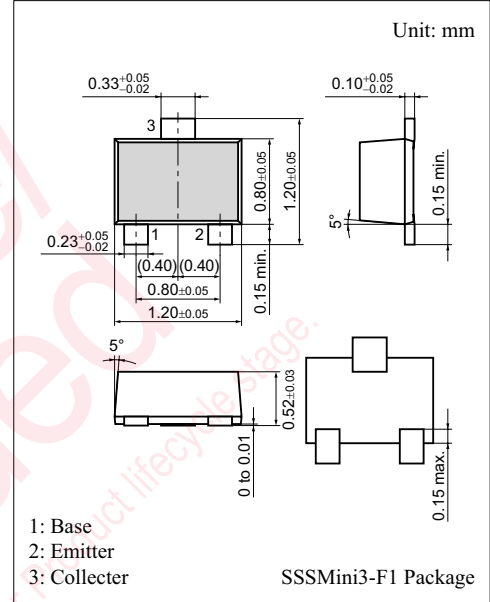
For general amplification  
 Complementary to 2SA2162

### ■ Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- SSS-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	15	V
Collector-emitter voltage (Base open)	$V_{CEO}$	12	V
Emitter-base voltage (Collector open)	$V_{EBO}$	5	V
Collector current	$I_C$	500	mA
Peak collector current	$I_{CP}$	1	A
Collector power dissipation	$P_C$	100	mW
Junction temperature	$T_j$	125	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +125	$^\circ\text{C}$

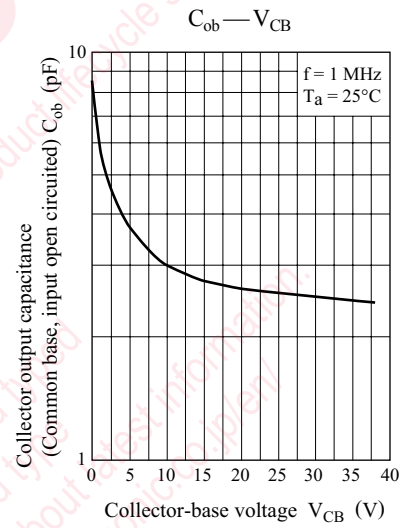
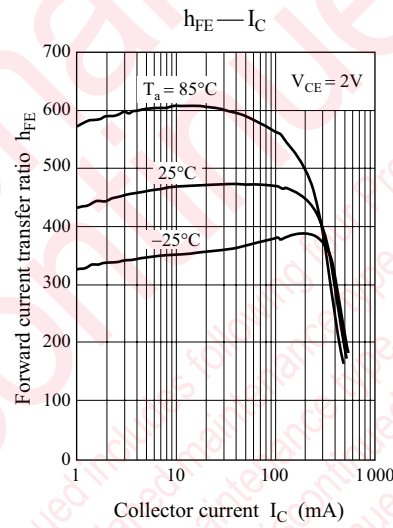
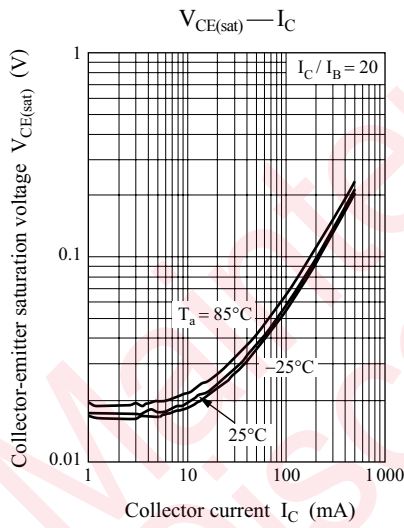
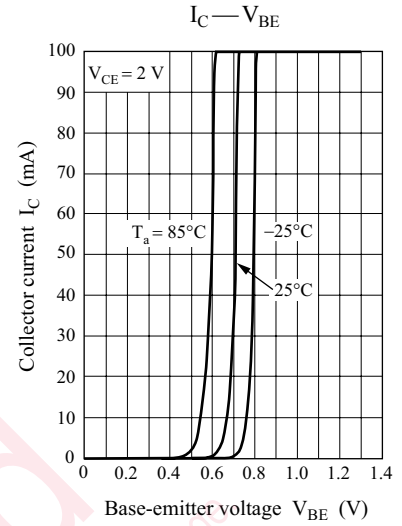
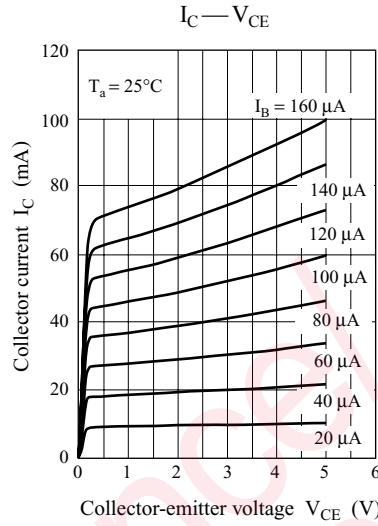
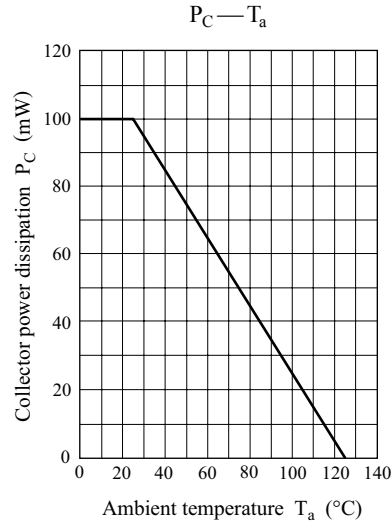


Marking Symbol : 4U

### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	$I_C = 10 \mu\text{A}, I_E = 0$	15			V
Collector-emitter voltage (Base open)	$V_{CEO}$	$I_C = 1 \text{ mA}, I_B = 0$	12			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu\text{A}, I_C = 0$	5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 10 \text{ V}, I_E = 0$			0.1	$\mu\text{A}$
Forward current transfer ratio	$h_{FE}$	$V_{CE} = 2 \text{ V}, I_C = 10 \text{ mA}$	270		680	—
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 200 \text{ mA}, I_B = 10 \text{ mA}$			250	mV
Transition frequency	$f_T$	$V_{CB} = 2 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance (Common base, input open circuited)	$C_{ob}$	$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$		4.5		pF

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



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